

**IN THE UNITED STATES  
PATENT AND TRADEMARK OFFICE**

In re Application of:	)	Group Art Unit: 2891
	)	
Pei-Haw Tsao <i>et al.</i>	)	Examiner: Dana Farahani
	)	
Serial No.: 10/711,503	)	
	)	
Filed: September 22, 2004	)	
	)	
For: <b>IC PACKAGE HAVING GROUND</b>	)	
<b>IC CHIP AND METHOD OF</b>	)	
<b>MANUFACTURING SAME</b>	)	

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Submitted via EFS

Mail Stop: **AF**  
Commissioner for Patents  
P.O. Box 1450  
Alexandria VA 22313-1450

Dear Sir:

**AMENDMENT IN RESPONSE TO OFFICE ACTION UNDER 37 C.F.R. 1.116**

This communication is in response to the Final Office Action of March 8, 2007. The Applicants note that the three month deadline for filing a response to this non-final Office Action is June 8, 2007; thus, this Response is timely. In addition, Applicant notes that the two-month deadline for filing a response to the Office Action is May 8, 2007; thus, this Response is being filed within the two-month shortened period for response under M.P.E.P. 706.07(f).